

MAIL STOP AF  
RESPONSE UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 1700

AF  
2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J.-S. Mok et al. Attorney Docket No.: LEPA121687  
Application No.: 10/677,182 Art Unit: 1765 / Confirmation No: 8329  
Filed: October 2, 2003 Examiner: S. Ahmed  
Title: METHOD OF FORMING SOLDER RESIST PATTERN

**AMENDMENT TRANSMITTAL LETTER**

Seattle, Washington 98101

November 22, 2006

TO THE COMMISSIONER FOR PATENTS:

A. Amendment Transmittal

Transmitted herewith is an amendment in the above-identified application.

- X 1. No additional claim fee is required, as shown below.  
\_\_\_\_\_ 2. The claim fee has been calculated as shown below.

COMPUTATION OF FEE FOR CLAIMS AS AMENDED

	Claims Remaining After Amendment		Highest Number Previously Paid For		Present Extra		Rate		Additional Fee
Total Claims	20	-	21	=	0	x	50	=	0
Independent Claims	6	-	6	=	0	x	200	=	0
TOTAL									\$0

B. Additional Fee Charges or Credit for Overpayment

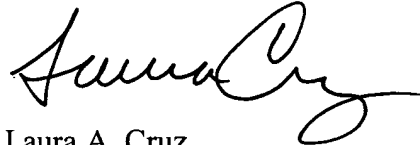
The Commissioner is hereby authorized to charge any fees under 37 C.F.R. §§ 1.16, 1.17 and 1.18 which may be required during the entire pendency of the application, or credit any overpayment, to Deposit Account No. 03-1740. This authorization also hereby includes a request

LAW OFFICES OF  
CHRISTENSEN O'CONNOR JOHNSON KINDNESS<sup>PLLC</sup>  
1420 Fifth Avenue  
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for any extensions of time of the appropriate length required upon the filing of any reply during the entire prosecution of this application.

Respectfully submitted,

CHRISTENSEN O'CONNOR  
JOHNSON KINDNESS<sup>PLLC</sup>

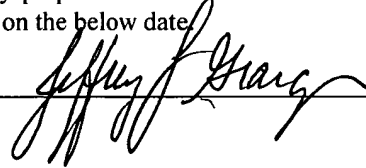


Laura A. Cruz  
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Direct Dial No. 206.695.1725

I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first-class mail with postage thereon fully prepaid and addressed to Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the below date.

Date:

November 22, 2006



LXC:nfs

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**AMENDMENT AFTER FINAL REJECTION**

Seattle, Washington 98101

November 22, 2006

TO THE COMMISSIONER FOR PATENTS:

Please amend the above-identified application as follows.